

## FEATURES

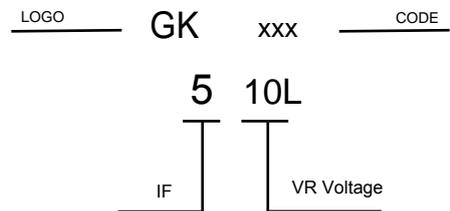
- \* Ideal for surface mount applications
- \* Easy pick and place
- \* Built-in strain relief
- \* Low forward voltage drop

## MECHANICAL DATA

- \* Case: Molded plastic
- \* Epoxy: UL 94V-0 rate flame retardant
- \* Metallurgically bonded construction
- \* Polarity: Color band denotes cathode end
- \* Mounting position: Any



**VOLTAGE RANGE**  
100 Volts  
**CURRENT**  
5.0 Ampere



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.  
Single phase half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

TYPE NUMBER	SS510L	UNITS
Maximum Recurrent Peak Reverse Voltage	100	V
Maximum RMS Voltage	70	V
Maximum DC Blocking Voltage	100	V
Maximum Average Forward Rectified Current		
See Fig. 1	5.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	120	A
Maximum Instantaneous Forward Voltage at 5.0A	0.67	V
Maximum DC Reverse Current Ta=25°C	0.1	mA
at Rated DC Blocking Voltage Ta=125°C	20	mA
Typical Junction Capacitance (Note1)	370	pF
Typical Thermal Resistance R JA (Note 2)	88	°C/W
Operating Temperature Range Tj	-55 →+150	°C
Storage Temperature Range Tstg	-55 →+150	°C

**NOTES:**

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. Unit mounted on PC board with 5.0mm× 5.0 mm (0.013 mm thick) copper pads as heat sink

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

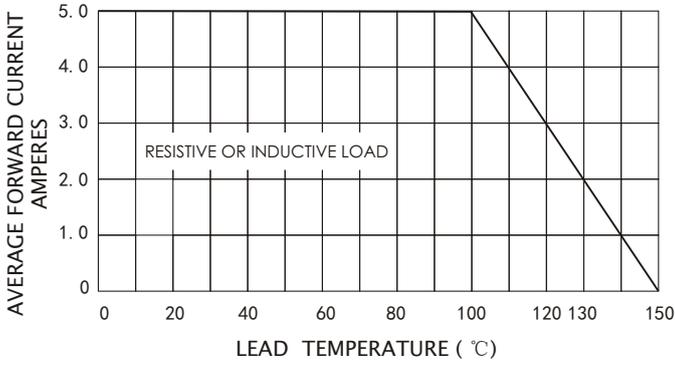


FIG.2-TYPICAL FORWARD CHARACTERISTICS

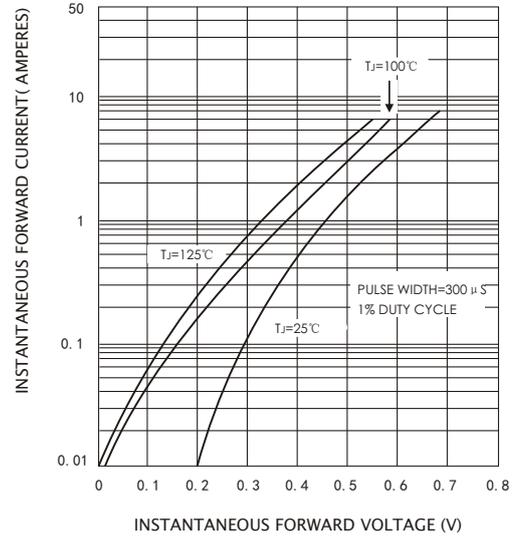


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

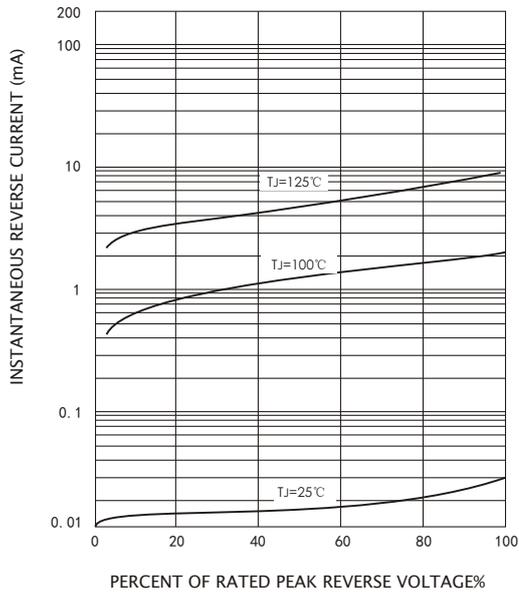


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

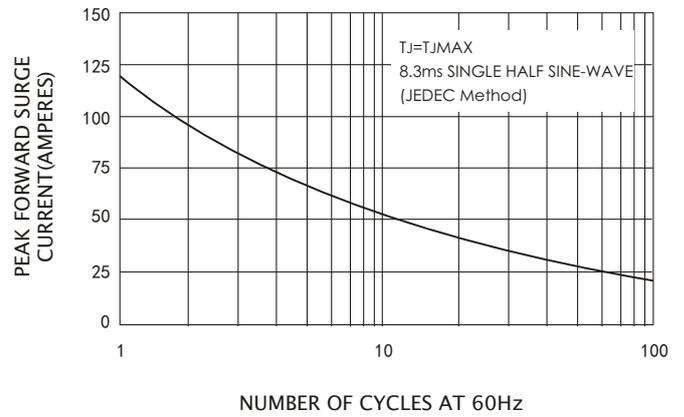
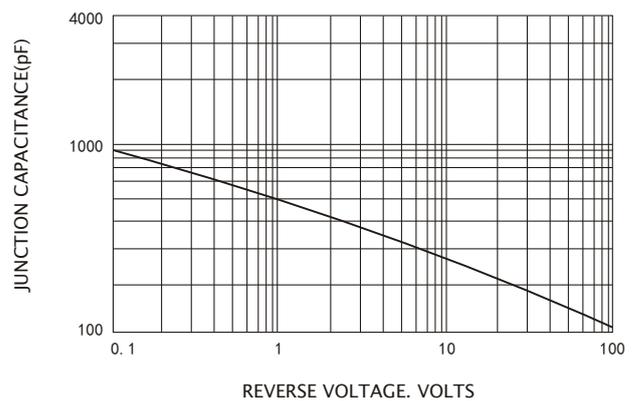
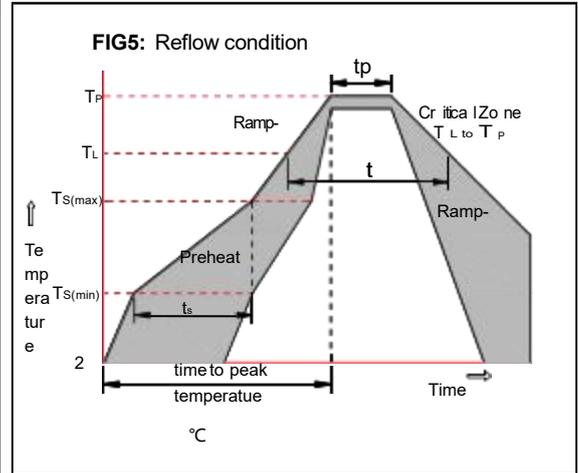


FIG.5-TYPICAL JUNCTION CAPACITANCE



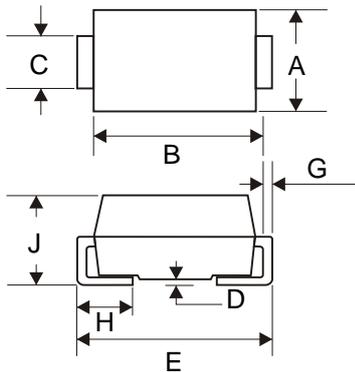
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ )(Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_P$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_P$ )		8 min. Max
Do not exceed		+260°C

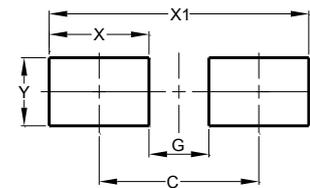


Package Dimensions & Suggested Pad Layout

SMA

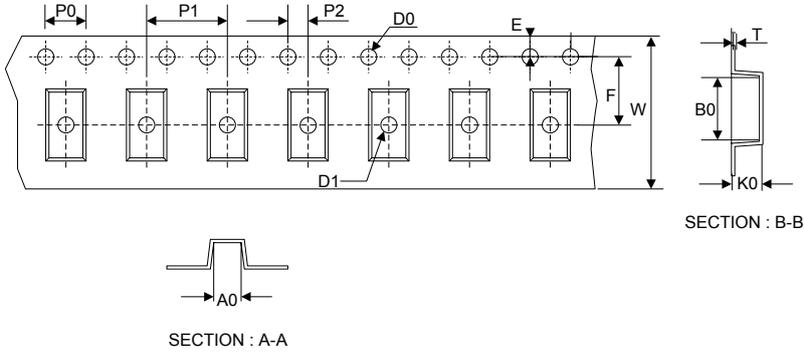
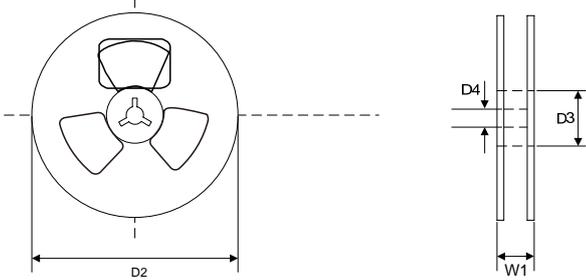
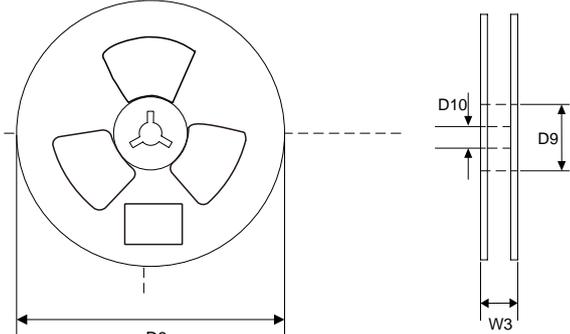


SMA		
Dim	Min	Max
A	2.40	2.79
B	3.99	4.50
C	1.32	1.47
D	-	0.20
E	4.93	5.28
G	0.15	0.31
H	0.76	1.52
J	1.98	2.29
All Dimensions in mm		



Dimensions	Value (in mm)
C	4.20
G	1.90
X	2.30
X1	6.50
Y	2.00

Tape & reel specification

Tape	Symbol	Dimension (mm)
	P0	4.00±0.20
	P1	4.00±0.20
	P2	2.00±0.20
	D0	1.60±0.20
	D1	1.60±0.20
	E	1.75±0.20
	F	5.50±0.15
	W	12.00±0.25
	A0	2.75±0.20
	B0	5.25±0.20
K0	2.45±0.25	
T	0.20±0.10	
<p>7" Reel</p> 	D2	176.0±5.0
	D3	55.0Min.
	D4	14.0±2.5
	W1	14.0±2.5
	Quantity: 2000PCS	
<p>13" Reel</p> 	D8	330.0±5.0
	D9	73.0Min.
	D10	14.0±2.5
	W3	14.0±2.5
	Quantity: 5000PCS	